

# **DATA SHEET**

## **SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS**

High Frequency Automotive Grade

NP0

16 V TO 50 V 0.2 pF to 100 pF RoHS compliant & Halogen Free



**YAGEO** Phicomp



#### SCOPE

This specification describes Automotive grade NPO series chip capacitors with lead-free terminations and used for automotive equipments.

#### **APPLICATIONS**

All general purpose applications Entertainment applications Comfort / security applications Information applications

#### **FEATURES**

- · AEC-Q200 qualified
- MSL class: MSL I
- AC series soldering is compliant with J-STD-020D
- · Halogen free epoxy
- RoHS compliant
- Reduce environmentally hazardous waste
- High component and equipment reliability
- The capacitors are 100% performed by automatic optical inspection prior to taping.

#### ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

#### **GLOBAL PART NUMBER**

AQ  $\underline{x}\underline{x}\underline{x}\underline{x}$   $\underline{x}$   $\underline{x}$   $\underline{x}\underline{x}\underline{x}$   $\underline{x}$  B  $\underline{x}$   $\underline{x}\underline{x}\underline{x}$ 

(1) (2) (3) (4) (5) (6) (7)

#### (I) SIZE - INCH BASED (METRIC)

0603 (1608)

#### (2) TOLERANCE

0.2pF to 2.0pF

 $A = \pm 0.05 pF$ 

 $B = \pm 0.1 pF$ 

 $C = \pm 0.25 \text{ pF}$ 

2.1pF to 5.0pF

 $A = \pm 0.05 pF$ 

 $B = \pm 0.1 pF$ 

 $C = \pm 0.25 pF$ 

 $D = \pm 0.5 pF$ 

5.1 pF to 9.9 pF

 $B = \pm 0.1 pF$ 

 $C = \pm 0.25 \text{ pF}$ 

 $D = \pm 0.5 pF$ 

10pF and over

 $F = \pm 1\%$ 

 $G = \pm 2\%$ 

 $| = \pm 5\%$ 

#### (3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch

P = Paper/PE taping reel; Reel 13 inch

#### (4) TC MATERIAL

NPO

#### (5) RATED VOLTAGE

7 = 16 V

8 = 25 V

9 = 50 V

#### (6) PROCESS

N = NP0

#### (7) CAPACITANCE VALUE

2 significant digits+number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

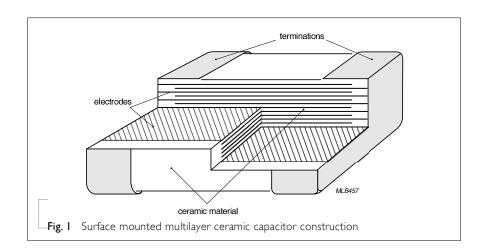
Example:  $121 = 12 \times 10^{1} = 120 \text{ pF}$ 

NP0

### CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (Matte Sn). The terminations are leadfree. A cross section of the structure is shown in Fig.I.

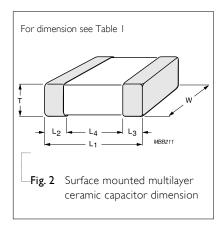


#### **DIMENSION**

**Table I** For outlines see fig. 2

TYPE	L <sub>I</sub> (mm)	mm) W (mm) T (MM)		L <sub>2</sub> /	L <sub>3</sub> (mm)	L <sub>4</sub> (mm)
1116	L  (IIIII)	** (11111)	. ()	min.	max.	min.
0603	1.6 ±0.10	0.8 ±0.10	0.8 ±0.10	0.20	0.60	0.40

#### **OUTLINES**





# Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade

16 V to 50 V NP0

## CAPACITANCE RANGE & THICKNESS FOR NPO

Table 3 Size	es 0603						
CAP.	0603			CAP.	0603		
	16 V	25 V	50 V		16 V	25 V	50 V
0.2 pF	0.8±0.1	0.8±0.1	0.8±0.1	9 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.3 pF	0.8±0.1	0.8±0.1	0.8±0.1	10 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.4 pF	0.8±0.1	0.8±0.1	0.8±0.1	12 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.5 pF	0.8±0.1	0.8±0.1	0.8±0.1	15 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.6 pF	0.8±0.1	0.8±0.1	0.8±0.1	18 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.7 pF	0.8±0.1	0.8±0.1	0.8±0.1	22 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.8 pF	0.8±0.1	0.8±0.1	0.8±0.1	27 pF	0.8±0.1	0.8±0.1	0.8±0.1
0.9 pF	0.8±0.1	0.8±0.1	0.8±0.1	33 pF	0.8±0.1	0.8±0.1	0.8±0.1
1.0 pF	0.8±0.1	0.8±0.1	0.8±0.1	39 pF	0.8±0.1	0.8±0.1	0.8±0.1
1.2 pF	0.8±0.1	0.8±0.1	0.8±0.1	47 pF	0.8±0.1	0.8±0.1	0.8±0.1
1.5 pF	0.8±0.1	0.8±0.1	0.8±0.1	56 pF	0.8±0.1	0.8±0.1	0.8±0.1
1.8 pF	0.8±0.1	0.8±0.1	0.8±0.1	68 pF	0.8±0.1	0.8±0.1	0.8±0.1
2.0 pF	0.8±0.1	0.8±0.1	0.8±0.1	82 pF	0.8±0.1	0.8±0.1	0.8±0.1
2.2 pF	0.8±0.1	0.8±0.1	0.8±0.1	100 pF	0.8±0.1	0.8±0.1	0.8±0.1
2.4 pF	0.8±0.1	0.8±0.1	0.8±0.1				
2.7 pF	0.8±0.1	0.8±0.1	0.8±0.1				
3.0 pF	0.8±0.1	0.8±0.1	0.8±0.1				
3.3 pF	0.8±0.1	0.8±0.1	0.8±0.1				
3.6 pF	0.8±0.1	0.8±0.1	0.8±0.1				
3.9 pF	0.8±0.1	0.8±0.1	0.8±0.1				
4.0 pF	0.8±0.1	0.8±0.1	0.8±0.1				
4.7 pF	0.8±0.1	0.8±0.1	0.8±0.1				
5.0 pF	0.8±0.1	0.8±0.1	0.8±0.1				
5.6 pF	0.8±0.1	0.8±0.1	0.8±0.1				
6.0 pF	0.8±0.1	0.8±0.1	0.8±0.1				
6.8 pF	0.8±0.1	0.8±0.1	0.8±0.1				
7.0 pF	0.8±0.1	0.8±0.1	0.8±0.1				
8.0 pF	0.8±0.1	0.8±0.1	0.8±0.1				
8.2 pF	0.8±0.1	0.8±0.1	0.8±0.1				

#### NOTE

- 1. Values in shaded cells indicate thickness class in mm
- 2. Capacitance value of non E-12 series is on request





### THICKNESS CLASSES AND PACKING QUANTITY

Table 13

SIZE	THICKNESS	TAPE WIDTH -	Ø180	MM / 7 INCH	Ø330	MM / 13 INCH
CODE	CLASSIFICATION	QUANTITY PER REEL	Paper	Blister	Paper	Blister
0603	0.8 ±0.1 mm	8 mm	4,000		15,000	

#### **ELECTRICAL CHARACTERISTICS**

#### NP0 DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C - Relative humidity: 25% to 75% - Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Tabl	le 14	
DESCRI	PTION	VALUE
Capacita	ance range	0.2 pF to 100 μpF
Capacita	ance tolerance	
NP0	C < 10 pF	±0.05 pF, ±0.1 pF, ±0.25 pF, ±0.5 pF
	C ≥ 10 pF	±1%, ±2%, ±5%
Dissipati	ion factor (D.F.)	
NP0	C < 30 pF	≤ I / ( 400 + 20C )
	C ≥ 30 pF	≤ 0.1 %
Insulatio	on resistance after I minute at U <sub>r</sub> (DC)	$IR \ge 10 \text{ G}\Omega$
	m capacitance change as a function of temperature rature characteristic/coefficient):	
NP0		±30 ppm/°C
Operatio	ng temperature range:	
NP0		_55 °C to +125 °C

## Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade

NP0 16 V to 50 V

### SOLDERING RECOMMENDATION Table 15

1 1 1 1 1 1 1					
SOLDERING METHOD	SIZE 0402	0603	0805	1206	≥ 1210
METHOD	0402	0603	0803	1206	≥ 1210
Reflow	≥0.1 µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave	< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	

#### **SOLDERING CONDITIONS**

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds
- Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202F-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 270 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

#### TESTS AND REQUIREMENTS

Table 16 Test procedures and requirements

TEST	TEST METHOD		PROCEDURE	REQUIREMENTS	
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage	
Capacitance	IEC 60384- 21/22	4.5.1	Class I: At 20 °C, 24 hours after annealing $f = 1 \text{ MHz}$ for $C \le 1 \text{ nF}$ , measuring at voltage $1 \text{ V}_{rms}$ at 20 °C	Within specified tolerance	
			f = 1 KHz for C > 1nF, measuring at voltage 1 $V_{rms}$ at 20 °C		
Dissipation Factor (D.F.)	IEC 60384- 21/22	4.5.2	Class I: At 20 °C, 24 hours after annealing $f = 1 \text{ MHz}$ for $C \le 1 \text{ nF}$ , measuring at voltage $1 \text{ V}_{rms}$ at	In accordance with specification	
			20 °C $f = I \text{ KHz for C} > I \text{ nF, measuring at voltage I V}_{\text{rms}} \text{ at } \\ 20 °C$		
Insulation Resistance	IEC 60384- 21/22	4.5.3	At U <sub>r</sub> (DC) for I minute	In accordance with specification	



NP0

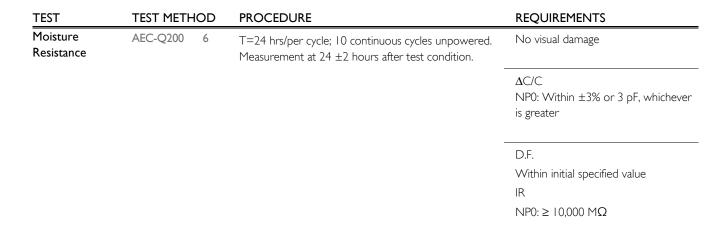
16 V to 50 V

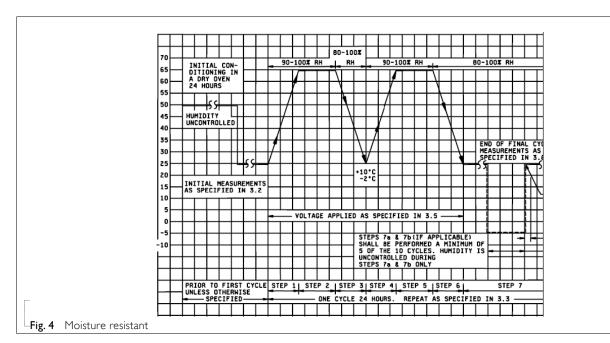
TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS
Temperature coefficient		4.6	Capacitance shall be measured by the steps shown in the following table.  The capacitance change should be measured after 5 min at each specified temperature stage.	<general purpose="" series=""> Class1: Δ C/C: ±30ppm</general>
			Step Temperature(°C)	
			a 25±2	
			b Lower temperature±3°C	
			c 25±2	
			d Upper Temperature±2° <b>C</b>	
			e 25±2	
			(I) Class I	
			Temperature Coefficient shall be calculated from the formula as below	
			Temp, Coefficient = $\frac{C2 - C1}{C1 \times \Delta T} \times 10^6 \text{ [ppm/°C]}$	
			C1: Capacitance at step c	
			C2: Capacitance at 125°C	
			$\Delta T$ : 100°C(=125°C-25°C)	
			(2) Class II	
			Capacitance Change shall be calculated from the	
			formula as below	
			$\Delta C = \frac{C2 - C1}{C1} \times 100\%$	
			C1: Capacitance at step c	
			C2: Capacitance at step b or d	
High	AEC-Q200	3	Unpowered; 1000hours @ T=150°C	No visual damage
Temperature			Measurement at 24±2 hours after test conclusion.	Δ C/C :
Exposure				Class I:
				NP0: within ±0.5% or 0.5 pF whichever is greater
Temperature Cycling	AEC-Q200	4	Preconditioning; 150 +0/-10 °C for 1 hour, then keep for	No visual damage
-			24 ±1 hours at room temperature	<u>Δ</u> C/C
				Class I:
			1000 cycles with following detail: 30 minutes at lower category temperature	NP0: Within $\pm 1\%$ or 0.5pF,
			30 minutes at upper category temperature	whichever is greater.
			Recovery time 24 ±2 hours	D.F. meet initial specified value IR meet initial specified value
Destructive	AEC-Q200	5	10ea X 3 lots.	
Physical Analysis			Note: Only applies to SMD ceramics. Electrical test not required.	

16 V to 50 V

NP0

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Biased Humidity AEC-Q200

1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for

24 ±1 hour at room temp

2. Initial measure:

Parameter: IR

Measuring voltage:  $1.5V \pm 0.1 \ VDC$ Note: Series with 100 K $\Omega$  & 6.8 K $\Omega$ 

3. Test condition:

85 °C, 85% R.H. connected with 100 K $\Omega$  resistor, applied 1.5V/U<sub>r</sub> for 1,000 hours.

4. Recovery:

Class I: 6 to 24 hours Class2: 24 ±2 hours

5. Final measure: IR

No visual damage after recovery

Initial requirement:

Class I:

- Connected to  $100 \text{ K}\Omega$ :

 $C \leq$  10 nF: I,R  $\geq$  10,000  $M\Omega$  or

 $C > 10 \text{ nF: } (I.R-100 \text{ K}\Omega) \times C \ge 100 \text{s.}$ 

- Connected to 6.8 K $\Omega$ :

 $C \leq$  10 nF: I,R  $\geq$  10,000 M $\Omega$  or

C > 10 nF: (I.R-6.8 K $\Omega$ )  $\times$   $C \ge 100s$ .

Final measurement:

The insulation resistance shall be greater than 0.1 time initial value.

NP0 16 V to 50 V

TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS		
Operational Life	AEC-Q200	8	1. Preconditioning, class 2 only:	No visual damage		
			150 +0/-10 °C /1 hour, then keep for	ΔC/C		
			24 ±1 hour at room temp	NP0: Within ±2% or 1 pF, whichever		
			2. Initial measure:	is greater		
			Spec: refer to initial spec C, D, IR			
			3. Endurance test:	D.F.		
			Specified stress voltage applied for 1,000 hours:	NP0: ≤ 2 × specified value.		
			Applied $2.0 \times U_r$ for general products			
			4. Recovery time: 24 ±2 hours	IR		
				NP0: $\geq 4,000 \text{ M}\Omega \text{ or } \text{IR} \times \text{C}_r \geq 40\text{s}$		
			5. Final measure: C, D, IR	whichever is less		
			Note: If the capacitance value is less than the minimum			
			value permitted, then after the other measurements			
			have been made the capacitor shall be preconditioned			
			according to "IEC 60384 4.1" and then the			
			requirement shall be met.			
External Visual	AEC-Q200	9	Any applicable method using × 10 magnification	In accordance with specification		
Physical	AEC-Q200	10	Verify physical dimensions to the applicable device	In accordance with specification		
Dimension			specification.			
Mechanical	AEC-Q200	13	Three shocks in each direction shall be applied along	ΔC/C		
Shock			the three mutually perpendicular axes of the test	NP0: Within $\pm 0.5\%$ or $0.5$ pF,		
			specimen (18 shocks)	whichever is greater		
			Peak value: 1,500 g's			
			Duration: 0.5 ms			
			Velocity change: 15.4 ft/s	D.F.		
			Waveform: Half-sin	Within initial specified value		
				IR		
				Within initial specified value		
Vibration	AEC-Q200	14	5 g's for 20 minutes, 12 cycles each of 3 orientations.	ΔC/C		
			Note:	NP0: Within $\pm 0.5\%$ or 0.5 pF,		
			Use 8" × 5" PCB, 0.31" thick 7 secure points on one	whichever is greater		
			long side and 2 secure points at corners of opposite			
			sides. Parts mounted within 2" from any secure point.	D.F: meet initial specified value		
			Test from	·		
			10-2000 Hz.	IR meet initial specified value		
Resistance to	AEC-Q200	15	Precondition: I50 +0/-I0 °C for I hour, then keep for	Dissolution of the end face plating		
Soldering Heat			$24 \pm 1$ hours at room temperature	shall not exceed 25% of the length of		
			Preheating: for size ≤ 1206: 120 °C to 150 °C for 1	the edge concerned		

NP0 16 V to 50 V

TEST	TEST METH	IOD	PROCEDURE	REQUIREMENTS
			minute  Preheating: for size > 1206: 100 °C to 120 °C for I minute and 170 °C to 200 °C for I minute  Solder bath temperature: 260 ±5 °C  Dipping time: 10 ±0.5 seconds  Recovery time: 24 ±2 hours	ΔC/C Class I: NP0: Within ±1% or 0.5 pF, whichever is greater.  D.F. within initial specified value
Thermal Shock	AEC-Q200	16	<ol> <li>Preconditioning, class 2 only:</li> <li>150 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp</li> <li>Initial measure:</li> <li>Spec: refer to initial spec C, D, IR</li> </ol>	IR within initial specified value   No visual damage $\Delta C/C$ NP0: Within $\pm 1\%$ or 1 pF, whichever is greater
			<ul> <li>3. Rapid change of temperature test: NP0: -55 °C to +125 °C; 300 cycles 15 minutes at lower category temperature; 15 minutes at upper category temperature. </li> <li>4. Recovery time: Class1: 6 to 24 hours Class2: 24 ±2 hours </li> <li>5. Final measure: C, D, IR</li> </ul>	D.F: meet initial specified value IR meet initial specified value
ESD	AEC-Q200	17	Per AEC-Q200-002	A component passes a voltage level if all components stressed at that voltage level pass.
Solderability	AEC-Q200	18	Preheated to a temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.  Test conditions for lead containing solder alloy Temperature: 235 ±5 °C Dipping time: 2 ±0.2 seconds Depth of immersion: 10 mm Alloy Composition: 60/40 Sn/Pb Number of immersions: I  Test conditions for lead-free containing solder alloy Temperature: 245 ±5 °C Dipping time: 3 ±0.3 seconds Depth of immersion: 10 mm Alloy Composition: SAC305 Number of immersions: I	The solder should cover over 95% of the critical area of each termination.
Electrical Characterization	AEC-Q200	19	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max operating temperatures.  Class I:  NP0: -55 °C to +125 °C  Normal temperature: 20 °C	ΔC/C Class I: NP0: ±30 ppm/°C

### **Surface-Mount Ceramic Multilayer Capacitors** | High

High Frequency Automotive grade

NP0

16 V to 50 V

#### **TEST TEST METHOD PROCEDURE REQUIREMENTS Board Flex** AEC-Q200 21 Part mounted on a 100 mm X 40 mm FR4 PCB board, No visible damage which is 1.6 ±0.2 mm thick and has a layer-thickness 35 $\mu m \pm 10 \mu m$ . ΔC/C Part should be mounted using the following soldering Class I: reflow profile. NP0: Within $\pm 1\%$ or 0.5 pF, Conditions: whichever is greater Class I: Bending 3 mm at a rate of 1 mm/s, radius jig 340 mm Test Substrate: Dimension(mm) Type b С ΥN Ф4.5 0201 0.3 0.9 0.3 0402 1.5 0.5 0603 1.0 3.0 12 1.65 0805 1.2 4.0 а 1206 2.2 5.0 1.65 100 1210 2.2 5.0 2.0 unit: mm 1808 3.5 7.0 3.7 **Terminal** AEC-Q200 22 With the component mounted on a PCB obtained Magnification of 20X or greater may Strength with the device to be tested, apply a 17.7N (1.8Kg) be employed for inspection of the force to the side of a device being tested. mechanical integrity of the device This force shall be applied for 60+1 seconds. body, terminals and body/terminal Also the force shall be applied gradually as not to apply junction. a shock to the component being tested. Before, during and after the test, the device shall comply with all electrical \* Apply 2N force for 0402 size. requirements stated in this specification. Beam Load Test AEC-Q200 23 ≤ 0805 Place the part in the beam load fixture. Apply a force Thickness > 0.5mm: 20N until the part breaks or the minimum acceptable force level required in the user specification(s) is attained. Thickness ≤ 0.5mm: 8N ≥ 1206 Thickness ≥1.25 mm: 54N Thickness < 1.25 mm: 15N

1. Specified stress voltage applied for 1~5 seconds

Charge/Discharge current is less than 50 mA

3.  $100 \text{ V} < \text{Ur} \le 200 \text{ V}$  series applied (1.5 Ur + 100) 4.  $200 \text{ V} < \text{Ur} \le 500 \text{ V}$  series applied (1.3 Ur + 100)

2. Ur ≤ 100 V: series applied 2.5 Ur

5. Ur > 500 V: 1.3 Ur6. Ur ≥ 1000 V: 1.2 Ur

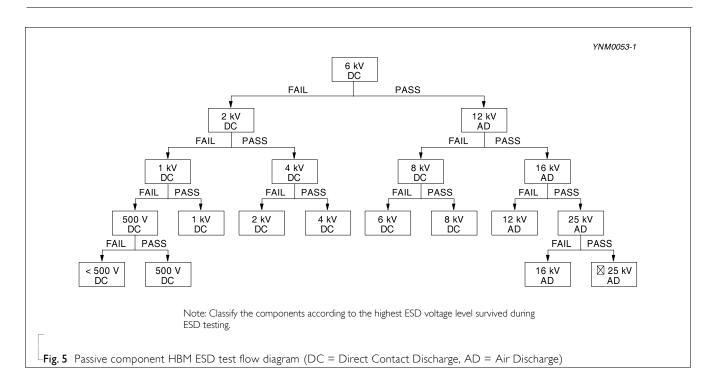


Voltage Proof

No breakdown or flashover

16 V to 50 V NP0

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
ESR		Measuring frequency: 1 ± 0.2GHz at room	$0.2pF \le C \le IpF: 350m\Omega / Cmax$
		temperature.	lpF < C ≤ 5pF:300mΩ max
			5pF < C ≤ 10pF : 250m <b>Ω</b> max
			C : Nominal cap (pF)
		Measuring frequency: $500 \pm 50$ MHz at room temperature.	$10pF < C \le 100pF : 400m\Omega \text{ max}$



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Product specification 14

Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade

NP0

16 V to 50 V

REVISION HISTORY

REVISION DATE **CHANGE NOTIFICATION DESCRIPTION** 

Version 0 Dec. 14, 2018 -- New

NP0

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 AQ0603ARNPO9BNR50
 AQ0603ARNPO9BNR60

 AQ0603ARNPO9BNR70
 AQ0603ARNPO9BNR80
 AQ0603ARNPO9BNR90
 AQ0603BRNPO9BNR60

 AQ0603BRNPO9BNR70
 AQ0603ARNPO9BN1R0
 AQ0603BRNPO9BNR70